



## Selected Papers from the NMJ2018

Guest Editors:

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**Prof. Dr. Jolanta Janczak-Rusch**

**Prof. Dr. Tomokazu Sano**

**Dr. Peng Peng**

Deadline for manuscript  
submissions:

**closed (1 January 2019)**

### Message from the Guest Editors

Dear Colleagues:

The 4th International Conference on Nanojoining and Microjoining will be held in Nara, Japan on December 2–5, 2018. The conference provides a platform for scientific and industrial discussion and exchange in the emerging fields of nano and micro joining technologies.

The main goal of this special issue is to advance the new science and technology in the fields of e.g. micro-electronics, medical implants, sensing devices and packaging, which have an urgent need for advanced joining technologies to integrate, package and assemble nano- and micro-scale materials and components at ever-low temperatures. We invite investigators interested in nano- and microjoining innovation to contribute to this issue with **400CHF** publication discount, the topics will cover all fields of NMJ2018.

Dr. Anming Hu  
Prof. Dr. Jolanta Janczak-Rusch  
Dr. Sano Tomokazu  
Dr. Peng Peng  
*Guest Editors*





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## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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